



# Product Change Notification

**Change Notification #:** 118253-00  
**Change Title:** Select Intel® Wireless 7200 Series,  
PCN 118253-00, Label, Transport Media  
Label and Packaging updates  
**Date of Publication:** May 12, 2021

**Key Characteristics of the Change:**  
Label, Transport Media

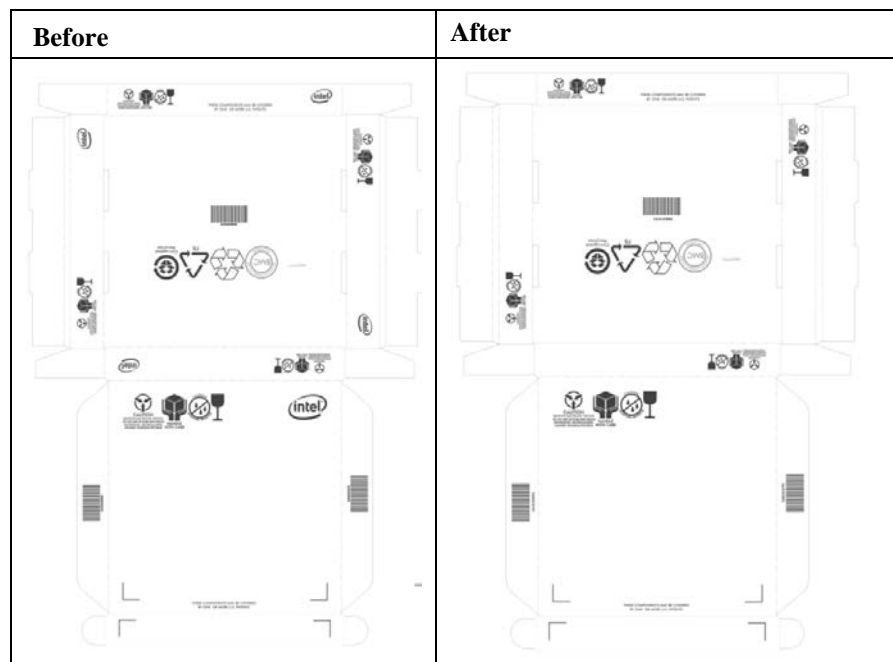
## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 31, 2021
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## Description of Change to the Customer:

The Intel® Wireless-AC7265 1216 SKUs listed in the products affected table below will undergo the following changes.

1. Update packaging kit from H55770-001 to H55770-002 (Remove old Intel logo from pizza box).



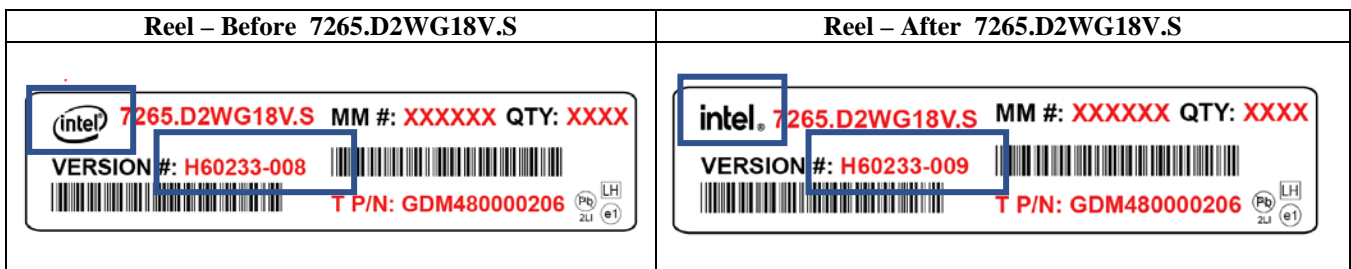
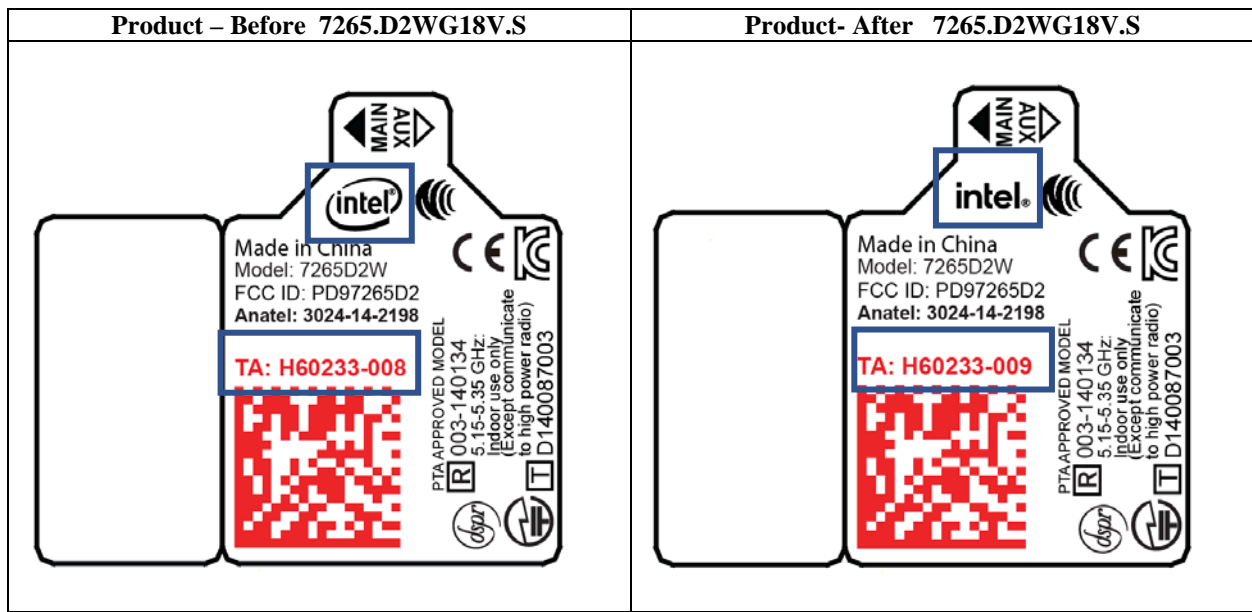
2. Update Intel logo on reel label and product label (laser marking).

- Update Singapore IMDA ID.
- Update UK/Brexit table on Disti label.
- The Intel tracking revision will be changed on the following products

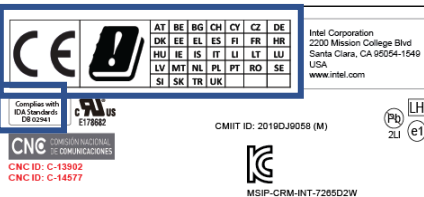
Product Code	Before	After
7265.D2WG.W	0F	0G
7265.D2WG18V.S1	0H	0I

- Product TA# dash up.

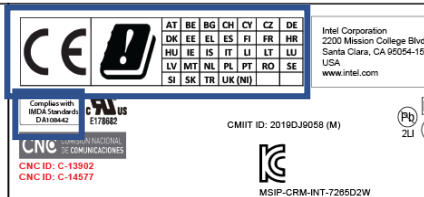
### Example Labels



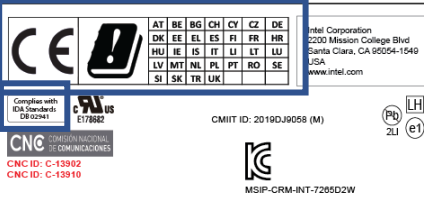
**Disti Label – Before 7265.D2WG18V.S**

<b>7265.D2WG18V.S</b> VERSION #: H60233-008 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 7265 (Model : 7265D2W) PKG ID (3S) VVVVMMMMDDDD####PPPPPP100 T P/N: GDM48000206	 Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com CMIIT ID: 2019DJ0058 (M) MSIP-CRM-INT-7265D2W
			D P/N: P P P P P P    REV AX X    HP P/N: XXXXXX-XXX    REV: XX Vendor ID   Loc Id    Mfg Id    L P/N: XXXXXXXXXXXX VVVVVLLLLL    M M M M M    EC: XXXXXX	

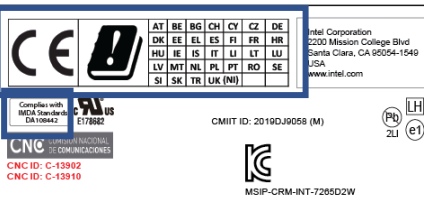
**Disti Label – After 7265.D2WG18V.S**

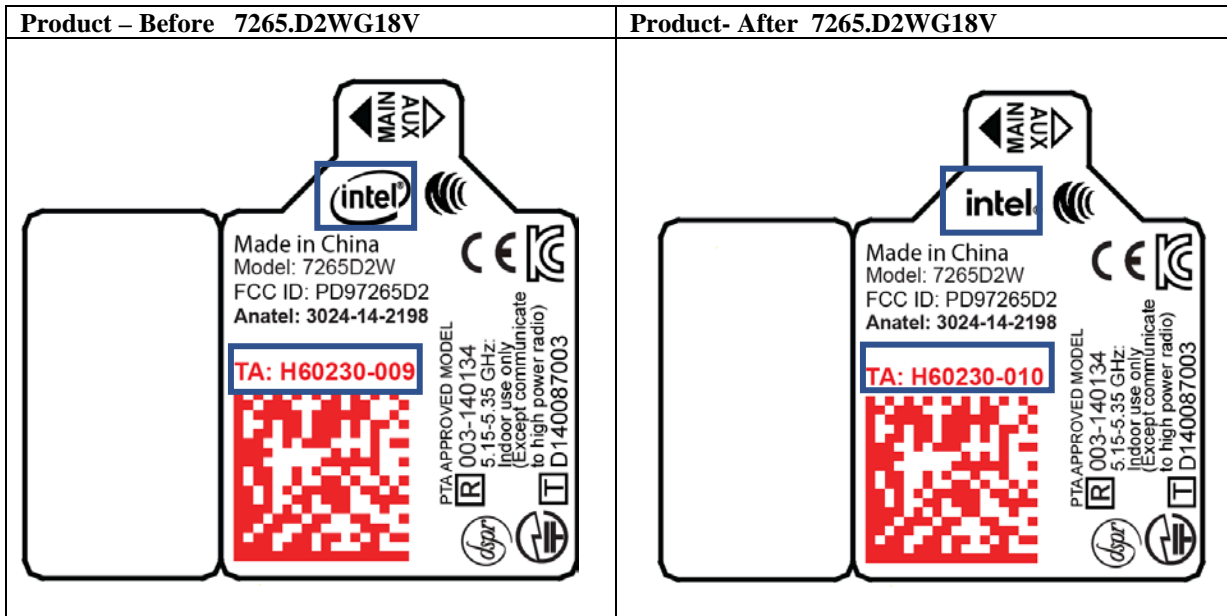
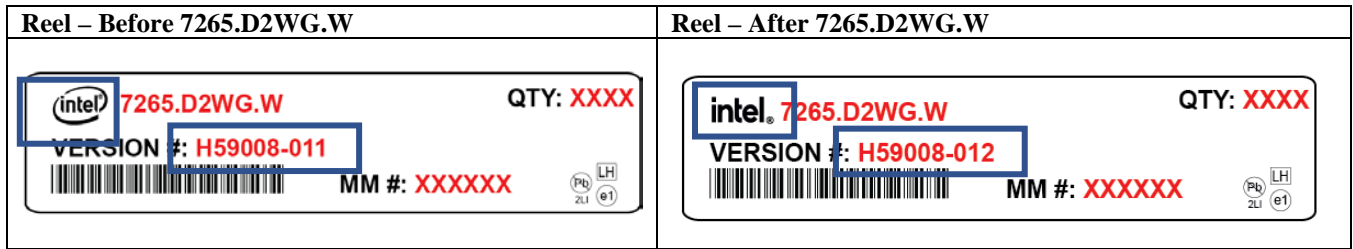
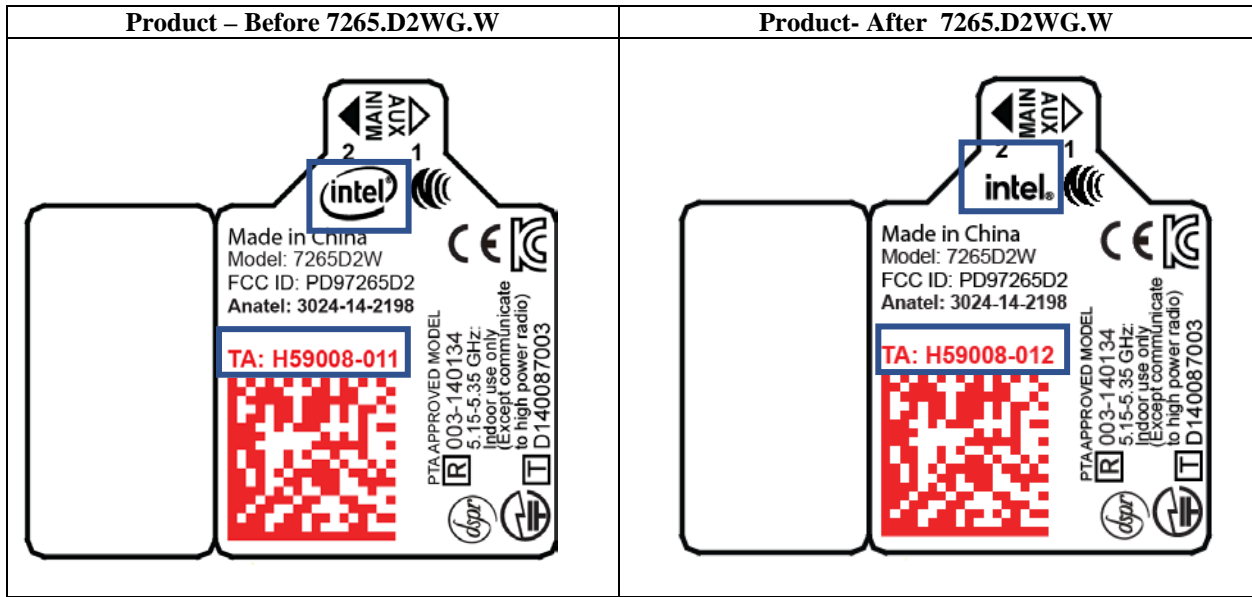
<b>7265.D2WG18V.S</b> VERSION #: H60233-008 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 7265 (Model : 7265D2W) PKG ID (3S) VVVVMMMMDDDD####PPPPPP100 T P/N: GDM48000206	 Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com CMIIT ID: 2019DJ0058 (M) MSIP-CRM-INT-7265D2W
			D P/N: P P P P P P    REV AX X    HP P/N: XXXXXX-XXX    REV: XX Vendor ID   Loc Id    Mfg Id    L P/N: XXXXXXXXXXXX VVVVVLLLLL    M M M M M    EC: XXXXXX	







**Disti Label – Before 7265.D2WG.W**

<b>7265.D2WG.W</b> VERSION #: H59008-011 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 7265 (Model : 7265.D2WG.W) PKG ID (3S) VVVVMMMMDDDD####PPPPPP100 T P/N: GTTTTTTTTTT	 Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com CMIIT ID: 2019DJ0058 (M) MSIP-CRM-INT-7265D2W
			D P/N: P P P P P P    REV AX X    HP P/N: 810316-001    REV: 0F Vendor ID   Loc Id    Mfg Id    L P/N: SW10A11619 VVVVVLLLLL    M M M M M    EC: 832609	

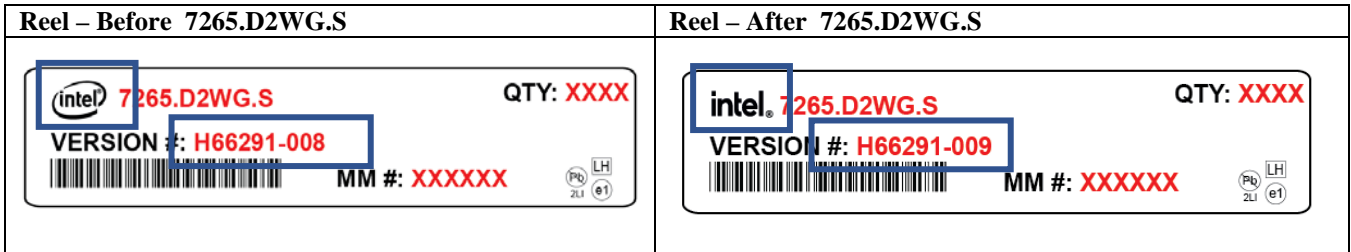
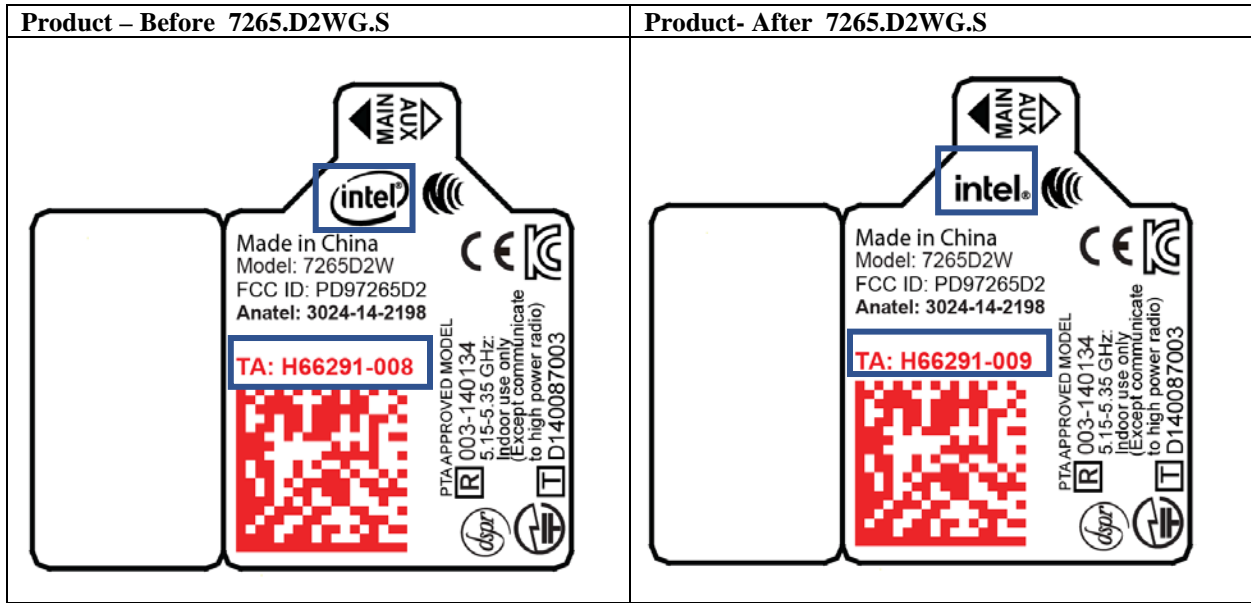
**Disti Label – After 7265.D2WG.W**

<b>7265.D2WG.W</b> VERSION #: H59008-012 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 7265 (Model : 7265.D2WG.W) PKG ID (3S) VVVVMMMMDDDD####PPPPPP100 T P/N: GTTTTTTTTTT	 Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com CMIIT ID: 2019DJ0058 (M) MSIP-CRM-INT-7265D2W
			D P/N: P P P P P P    REV AX X    HP P/N: 810316-001    REV: 0F Vendor ID   Loc Id    Mfg Id    L P/N: SW10A11619 VVVVVLLLLL    M M M M M    EC: 832609	



<b>Reel – Before 7265.D2WG18V</b>	<b>Reel – After 7265.D2WG18V</b>
 <b>7265.D2WG18V</b> <b>QTY: XXXX</b> <b>VERSION #: H60230-009</b>  <b>MM #: XXXXXX</b> 	 <b>7265.D2WG18V</b> <b>QTY: XXXX</b> <b>VERSION #: H60230-010</b>  <b>MM #: XXXXXX</b> 

<b>Disti Label – Before 7265.D2WG18V</b>			
<b>7265.D2WG18V</b>  <b>VERSION #: H60230-009</b>  <b>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</b>  <b>CARTON #: VVXXXXXXXX</b>	<b>QTY: 100</b> <b>MM#: XXXXXX</b>  <b>PACK DATE: DD MMM YY</b> <b>PACKED BY: XXXXXX</b> <b>BATCH #: CCVVYMDRSS</b> 	 1 88334 00140 2  9 310779 300005	<b>Intel® Dual Band Wireless-AC 7265 (Model : 7265D2W)</b> <b>PKG ID (3S) VVVVMMMMDDDD####PPPPPP100</b>  <b>T P/N: GTTTTTTTTTT</b> <b>D P/N: P P P P P P    REV AX X    HP P/N: XXXXX-XXX    REV: XX</b>   <b>PACKAGE WEIGHT: X.X LBS</b> <b>Vendor ID   Loc Id    Mfg Id    L P/N: SW10M73248</b>    <b>EC: 1854498</b>
<b>Disti Label – After 7265.D2WG18V</b>			
<b>7265.D2WG18V</b>  <b>VERSION #: H60230-010</b>  <b>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</b>  <b>CARTON #: VVXXXXXXXX</b>	<b>QTY: 100</b> <b>MM#: XXXXXX</b>  <b>PACK DATE: DD MMM YY</b> <b>PACKED BY: XXXXXX</b> <b>BATCH #: CCVVYMDRSS</b> 	 1 88334 00140 2  9 310779 300005	<b>Intel® Dual Band Wireless-AC 7265 (Model : 7265D2W)</b> <b>PKG ID (3S) VVVVMMMMDDDD####PPPPPP100</b>  <b>T P/N: GTTTTTTTTTT</b> <b>D P/N: P P P P P P    REV AX X    HP P/N: XXXXX-XXX    REV: XX</b>   <b>PACKAGE WEIGHT: X.X LBS</b> <b>Vendor ID   Loc Id    Mfg Id    L P/N: SW10M73248</b>    <b>EC: 1854498</b>



**Disti Label – Before 7265.D2WG.S**

<p><b>7265.D2WG.S</b></p> <p>VERSION #: <b>H66291-008</b></p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXXX</b></p>	<p><b>MM#: XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p><b>QTY: 100</b></p> <p>88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 7265 (Model : 7265.D2WG.S)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD####PPPPPP100</b></p> <p>T P/N: GTTTTTTTTTT</p>	<table border="1"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Complies with IEC Standard DA 10842 E17862</p> <p>CNC COMERCIAL DE COMUNICACIONES CNC ID: C-13902 CNC ID: C-14577</p> <p>CMIT ID: 2019DJ0058 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
			AT		BE	BG	CH	CY	CZ	DE																													
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HU	IE	IS	IT	LI	LT	LU																																	
LV	MT	NL	PL	PT	RO	SE																																	
SI	SK	TR	UK																																				
<p>D P/N: <b>PPPPPP</b>    REV <b>AXX</b>    HP P/N: <b>XXXXXX-XXX</b>    REV: <b>XX</b></p> <p>Vendor ID   Loc Id    Mfg Id    L P/N: <b>XXXXXXXXXX</b></p> <p><b>VVVVVLLLLL</b>    <b>MMMMM</b>    <b>XXXXXXXXXX</b></p> <p>EC: <b>XXXXXX</b></p>																																							

**Disti Label – After 7265.D2WG.S**

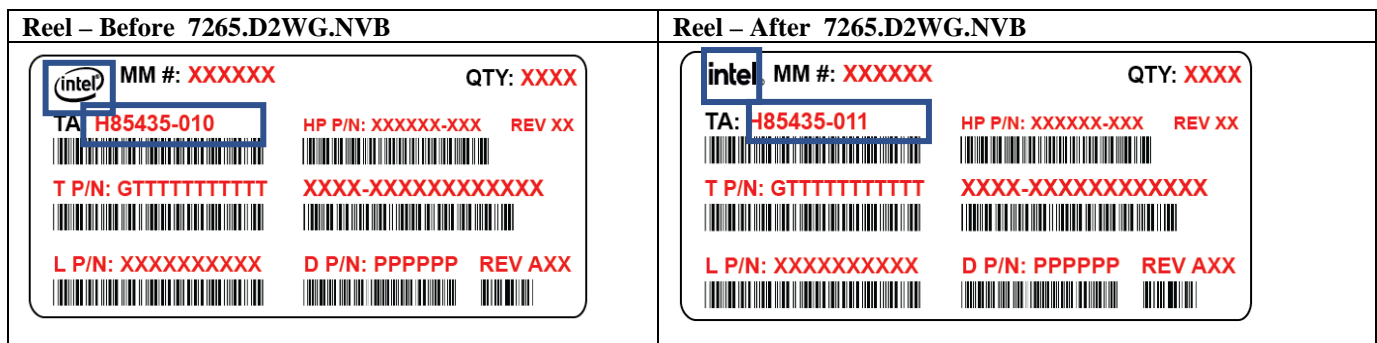
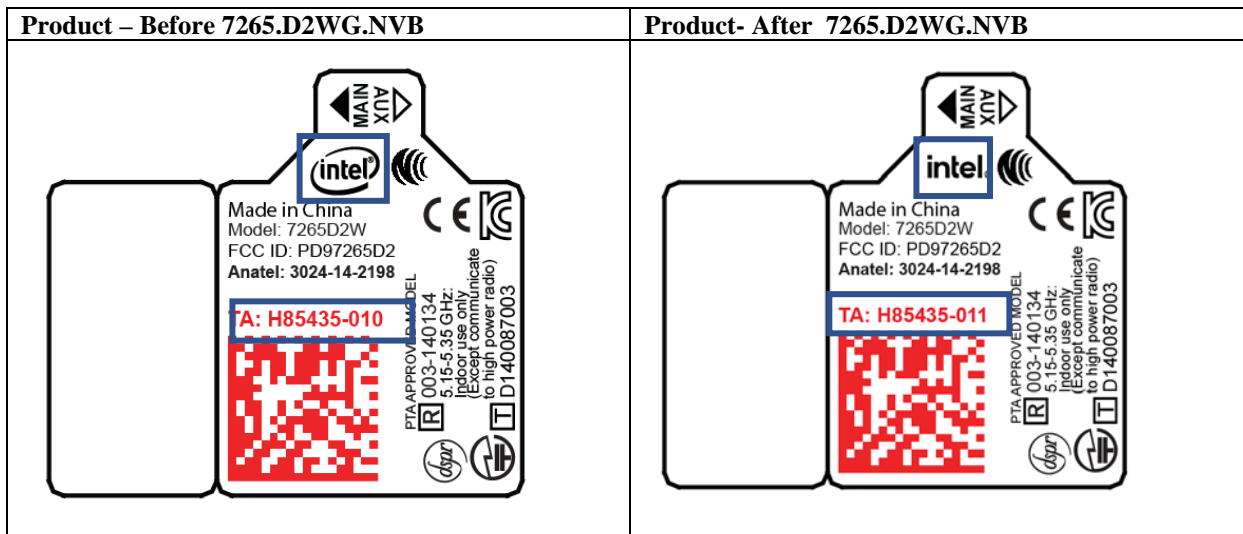
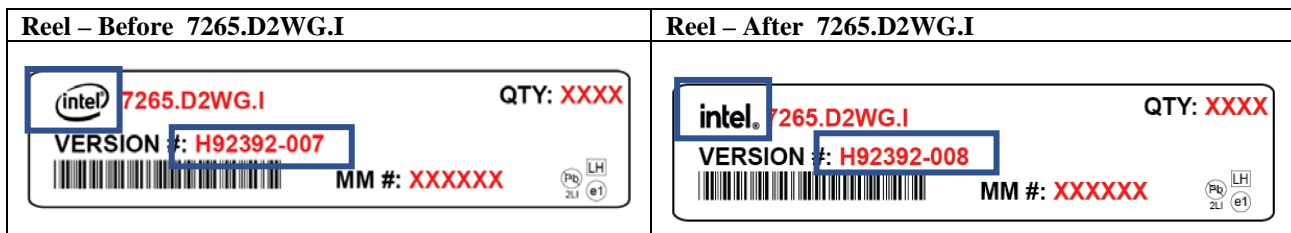
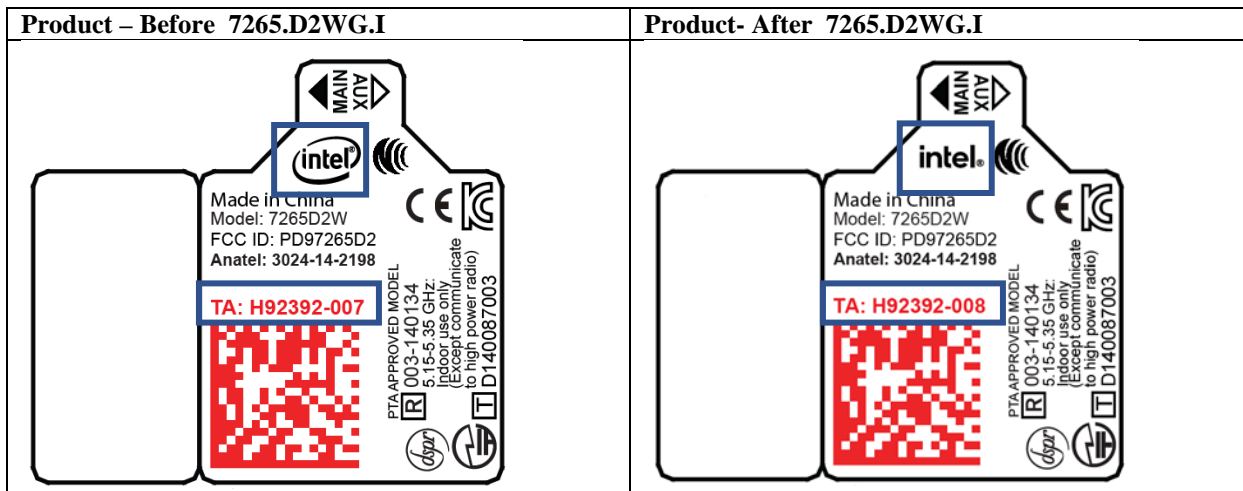
<p><b>7265.D2WG.S</b></p> <p>VERSION #: <b>H66291-009</b></p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXXX</b></p>	<p><b>MM#: XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p><b>QTY: 100</b></p> <p>88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 7265 (Model : 7265.D2WG.S)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD####PPPPPP100</b></p> <p>T P/N: GTTTTTTTTTT</p>	<table border="1"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td>(N)</td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Complies with IEC Standard DA 10842 E17862</p> <p>CNC COMERCIAL DE COMUNICACIONES CNC ID: C-13902 CNC ID: C-14577</p> <p>CMIT ID: 2019DJ0058 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK	(N)		
			AT		BE	BG	CH	CY	CZ	DE																													
DK	EE	EL	ES	FI	FR	HR																																	
HU	IE	IS	IT	LI	LT	LU																																	
LV	MT	NL	PL	PT	RO	SE																																	
SI	SK	TR	UK	(N)																																			
<p>D P/N: <b>PPPPPP</b>    REV <b>AXX</b>    HP P/N: <b>XXXXXX-XXX</b>    REV: <b>XX</b></p> <p>Vendor ID   Loc Id    Mfg Id    L P/N: <b>XXXXXXXXXX</b></p> <p><b>VVVVVLLLLL</b>    <b>MMMMM</b>    <b>XXXXXXXXXX</b></p> <p>EC: <b>XXXXXX</b></p>																																							

**Disti Label - Before 7265.D2WG.I**

<p><b>7265.D2WG.I</b></p> <p>VERSION #: <b>H92392-007</b></p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXXX</b></p>	<p><b>MM#: XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p><b>QTY: 100</b></p> <p>88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 7265 (Model: 7265D2W)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD####PPPPPP100</b></p> <p>T P/N: GTTTTTTTTTT</p>	<table border="1"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td>(W)</td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Complies with IEC Standard DA 10842 E17862</p> <p>CNC COMERCIAL DE COMUNICACIONES CNC ID: C-13902 CNC ID: C-14577</p> <p>CMIT ID: 2019DJ0058 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK	(W)		
			AT		BE	BG	CH	CY	CZ	DE																													
DK	EE	EL	ES	FI	FR	HR																																	
HU	IE	IS	IT	LI	LT	LU																																	
LV	MT	NL	PL	PT	RO	SE																																	
SI	SK	TR	UK	(W)																																			
<p>D P/N: <b>PPPPPP</b>    REV <b>AXX</b>    HP P/N: <b>XXXXXX-XXX</b>    REV: <b>XX</b></p> <p>Vendor ID   Loc Id    Mfg Id    L P/N: <b>XXXXXXXXXX</b></p> <p><b>VVVVVLLLLL</b>    <b>MMMMM</b>    <b>XXXXXXXXXX</b></p> <p>EC: <b>XXXXXX</b></p>																																							

**Disti Label - After 7265.D2WG.I**

<p><b>7265.D2WG.I</b></p> <p>VERSION #: <b>H92392-008</b></p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: <b>VVXXXXXXXX</b></p>	<p><b>MM#: XXXXXX</b></p> <p>PACK DATE: <b>DD MMM YY</b> PACKED BY: <b>XXXXXX</b></p> <p>BATCH #: <b>CCVYMDRSS</b></p>	<p><b>QTY: 100</b></p> <p>88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 7265 (Model: 7265D2W)</p> <p>PKG ID (3S) <b>VVVVMMMMDDDD####PPPPPP100</b></p> <p>T P/N: GTTTTTTTTTT</p>	<table border="1"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td>(W)</td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Complies with IEC Standard DA 10842 E17862</p> <p>CNC COMERCIAL DE COMUNICACIONES CNC ID: C-13902 CNC ID: C-14577</p> <p>CMIT ID: 2019DJ0058 (M)</p> <p>MSIP-CRM-INT-7265D2W</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK	(W)		
			AT		BE	BG	CH	CY	CZ	DE																													
DK	EE	EL	ES	FI	FR	HR																																	
HU	IE	IS	IT	LI	LT	LU																																	
LV	MT	NL	PL	PT	RO	SE																																	
SI	SK	TR	UK	(W)																																			
<p>D P/N: <b>PPPPPP</b>    REV <b>AXX</b>    HP P/N: <b>XXXXXX-XXX</b>    REV: <b>XX</b></p> <p>Vendor ID   Loc Id    Mfg Id    L P/N: <b>XXXXXXXXXX</b></p> <p><b>VVVVVLLLLL</b>    <b>MMMMM</b>    <b>XXXXXXXXXX</b></p> <p>EC: <b>XXXXXX</b></p>																																							





## Customer Impact of Change and Recommended Action:

The label and packaging changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Dual Band Wireless-AC 7265, 2x2 AC + BT, 1.8V No vPro® M.2, Low Power	7265.D2WG18V.S	934460	H60233-008	H60233-009
Intel® Dual Band Wireless-AC 7265, 2x2 AC + BT, vPro® M.2	7265.D2WG.W	939403	H59008-011	H59008-012
Intel® Dual Band Wireless-AC 7265, 2x2 AC + BT, 1.8V vPro® M.2	7265.D2WG18V	934449	H60230-009	H60230-010
Intel® Dual Band Wireless-AC 7265, 2x2 AC + BT, vPro® M.2, Low Power	7265.D2WG.S	934470	H66291-008	H66291-009
Intel® Dual Band Wireless-AC 7265, 2x2 AC + BT, vPro® M.2, (Indonesia)	7265.D2WG.I	936899	H92392-007	H92392-008
Intel® Dual Band Wireless-AC 7265, 2x2 AC + BT, M.2, No vPro®	7265.D2WG.NVB	944431	H85435-010	H85435-011

## PCN Revision History:

**Date of Revision:**

May 12, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 118253-00

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